### INTEGRATED CIRCUITS

## DATA SHEET

# **74F298**Quad 2-input multiplexer with storage

Product specification

1989 Aug 14

IC15 Data Handbook





74F298

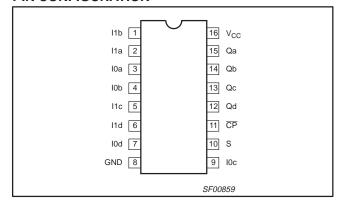
### **FEATURES**

- Fully synchronous operation
- Select from two data sources
- Buffered, negative edge triggered clock
- Provides the equivalent of function capabilities of two separate MSI functions (74F157 and 74F175)

### **DESCRIPTION**

The 74F298 is a high speed Quad 2-Input Multiplexer with storage. It selects 4 bits of data from two sources (ports) under the control of a common Select input (S). The selected data is transferred to the 4-bit output register synchronous with the High-to-Low transition of the clock (CP). The 4-bit register is fully edge triggered. The data inputs (I0 and I1) and Select input (S) must be stable only one setup time prior to the High-to-Low transition of the clock for predictable operation.

### **PIN CONFIGURATION**



TYPE	TYPICAL f <sub>MAX</sub>	TYPICAL SUPPLY CURRENT (TOTAL)
74F298	115MHz	30mA

### ORDERING INFORMATION

	ORDER CODE		
DESCRIPTION	COMMERCIAL RANGE $V_{CC}$ = 5V $\pm 10\%$ , $T_{amb}$ = 0°C to +70°C	PKG DWG #	
16-pin plastic DIP	N74F298N	SOT38-4	
16-pin plastic SO	N74F298D	SOT109-1	

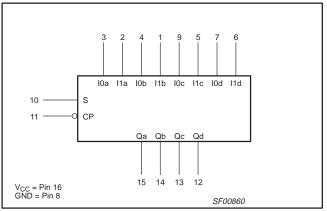
### INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW		
10a, 10b, 10c, 10d	Data inputs	1.0/1.0	20μA/0.6mA		
l1a, l1b, l1c, l1d	Data inputs	1.0/1.0	20μA/0.6mA		
S	Select input	1.0/1.0	20μA/0.6mA		
CP	Clock input (active falling edge)	1.0/1.0	20μA/0.6mA		
Qa, Qb, Qc, Qd	Data outputs	50/33	1.0mA/20mA		

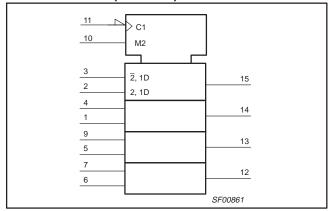
### NOTE:

One (1.0) FAST unit load is defined as:  $20\mu A$  in the High state and 0.6mA in the Low state.

### **LOGIC SYMBOL**



### LOGIC SYMBOL (IEEE/IEC)

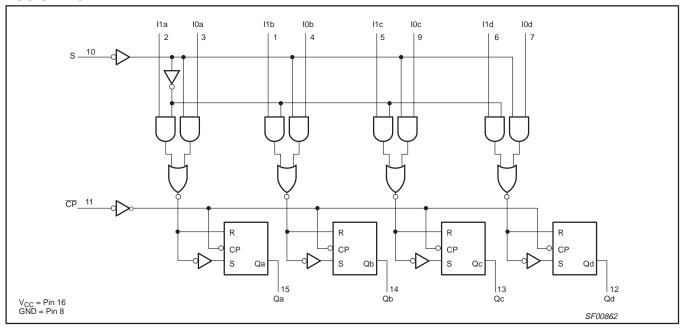


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### **LOGIC DIAGRAM**



### **FUNCTION TABLE**

	INP	UTS		OUTPUT	OBERATING MODE			
CP	S	I0n	l1n	Qn	OPERATING MODE			
<b>1</b>	I	I	Х	L	Load source "0"			
$\downarrow$	I	h	Х	Н	Load source o			
<b>\</b>	h	Х	I	L	Load source "1"			
$\downarrow$	h	Х	h	Н	Load Source 1			

Н

High voltage level High voltage level one setup time prior to the High-to-Low h

clock transition

Low voltage level

Low voltage level one setup time prior to the High-to-Low

clock transition

Don't care X

High-to-Low clock transition

### **ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT	
V <sub>CC</sub>	Supply voltage	-0.5 to +7.0	V	
V <sub>IN</sub>	Input voltage	-0.5 to +7.0	V	
I <sub>IN</sub>	Input current	-30 to +5	mA	
V <sub>OUT</sub>	Voltage applied to output in High output state	−0.5 to V <sub>CC</sub>	V	
I <sub>OUT</sub>	Current applied to output in Low output state	40	mA	
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C	
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C	

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### RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER			UNIT	
STWIBUL	PARAMETER	MIN	NOM	MAX	UNII
V <sub>CC</sub>	Supply voltage	4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0			V
V <sub>IL</sub>	Low-level input voltage			0.8	V
I <sub>IK</sub>	Input clamp current			-18	mA
I <sub>OH</sub>	High-level output current			-1	mA
I <sub>OL</sub>	Low-level output current			20	mA
T <sub>amb</sub>	Operating free-air temperature range	0		70	°C

### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIONS <sup>NO</sup>	MIN	TYP NO TAG	MAX	UNIT	
V	Lligh lovel output voltage		V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX,	±10%V <sub>CC</sub>	2.5			V
V <sub>OH</sub>	High-level output voltage		$V_{CC} = MIN, V_{IL} = MAX,$ $V_{IH} = MIN, I_{OH} = -MAX$	±5%V <sub>CC</sub>	2.7	3.4		V
	l and land and and and		V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX,	±10%V <sub>CC</sub>		0.30	0.50	V
V <sub>OL</sub>	Low-level output voltage		V <sub>IH</sub> = MIN, I <sub>OL</sub> =– MAX	±5%V <sub>CC</sub>		0.30	0.50	V
V <sub>IK</sub>	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$		-0.73	-1.2	V	
l <sub>l</sub>	Input current at maximum in	put voltage	$V_{CC} = MAX, V_I = 7.0V$			100	μΑ	
I <sub>IH</sub>	High-level input current		$V_{CC} = MAX, V_I = 2.7V$			20	μΑ	
I <sub>IL</sub>	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$			-0.6	mA	
Ios	Short-circuit output current <sup>N</sup>	O TAG	V <sub>CC</sub> = MAX	-60		-150	mA	
	I <sub>CCH</sub>		V MAY		30	40	mA	
Icc	Supply current (total)	I <sub>CCL</sub>	$V_{CC} = MAX$		32	40	mA	

### NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

2. All typical values are at  $V_{CC}$  = 5V,  $T_{amb}$  = 25°C.

### **AC ELECTRICAL CHARACTERISTICS**

SYMBOL	PARAMETER	TEST CONDITION	(	<sub>mb</sub> = +25° <sub>CC</sub> = +5.0 C <sub>L</sub> = 50pF R <sub>L</sub> = 500Ω		T <sub>amb</sub> = 0°C V <sub>CC</sub> = +5. C <sub>L</sub> = R <sub>L</sub> =	UNIT	
			MIN	TYP	MAX	MIN	MAX	
f <sub>MAX</sub>	Maximum clock frequency	Waveform NO TAG	110	115		105		ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay CP tp Qn	Waveform NO TAG	4.0 4.5	5.5 6.5	7.5 8.5	4.0 4.5	9.0 9.5	ns

<sup>3.</sup> Not more than one output should be shorted at a time. For testing I<sub>OS</sub>, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

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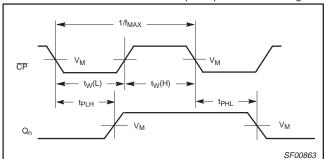
### **AC SETUP REQUIREMENTS**

SYMBOL	PARAMETER	TEST CONDITION	V	<sub>mb</sub> = +25° cc = +5.0 C <sub>L</sub> = 50pF R <sub>L</sub> = 500Ω	V =	T <sub>amb</sub> = 0°0 V <sub>CC</sub> = +5. C <sub>L</sub> = R <sub>L</sub> =	UNIT	
			MIN	TYP	MAX	MIN	MAX	]
t <sub>S</sub> (H) t <sub>S</sub> (L)	Setup time, High or Low I0n, I1n to CP	Waveform NO TAG	2.0 2.0			2.0 2.0		ns
t <sub>h</sub> (H) t <sub>h</sub> (L)	Hold time, High or Low I0n, I1n to CP	Waveform NO TAG	1.0 1.0			1.0 1.0		ns
t <sub>s</sub> (H) t <sub>s</sub> (L)	Setup time, High or Low S to CP	Waveform NO TAG	6.0 5.0			7.0 6.0		ns
t <sub>h</sub> (H) t <sub>h</sub> (L)	Hold time, High or Low S to $\overline{CP}$	Waveform NO TAG	0			0 0		ns
t <sub>w</sub> (H) t <sub>w</sub> (L)	CP Pulse width, High or Low	Waveform NO TAG	5.0 5.0			5.0 7.0		ns

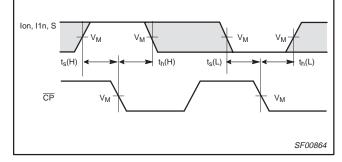
### **AC WAVEFORMS**

For all waveforms,  $V_M = 1.5V$ .

The shaded areas indicate when the input is permitted to change for predictable output performance.

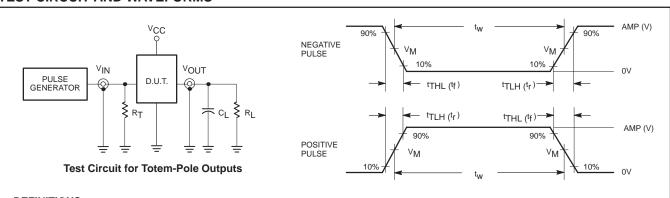


Waveform 1. Clock Input to Output, Clock Pulse Width, and Maximum Clock Frequency



Waveform 2. Data Setup and Hold Times

### **TEST CIRCUIT AND WAVEFORMS**



### **DEFINITIONS:**

R<sub>L</sub> = Load resistor;

see AC ELECTRICAL CHARACTERISTICS for value.

C<sub>L</sub> = Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value.

 $R_T$  = Termination resistance should be equal to  $Z_{OUT}$  of pulse generators.

### Input Pulse Definition

family	INP	INPUT PULSE REQUIREMENTS											
family	amplitude	$V_{\text{M}}$	V <sub>M</sub> rep. rate		t <sub>TLH</sub>	t <sub>THL</sub>							
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns							

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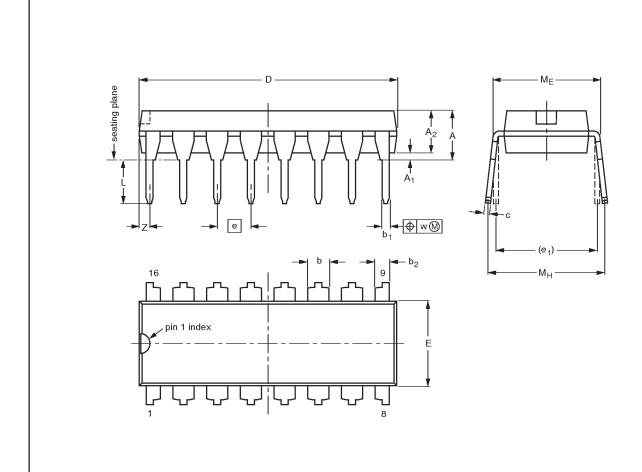
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### Quad 2-input multiplexer with storage

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### DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	ь	b <sub>1</sub>	b <sub>2</sub>	O	D <sup>(1)</sup>	E <sup>(1)</sup>	Φ	e <sub>1</sub>	L	ME	Мн	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

scale

10 mm

#### Note

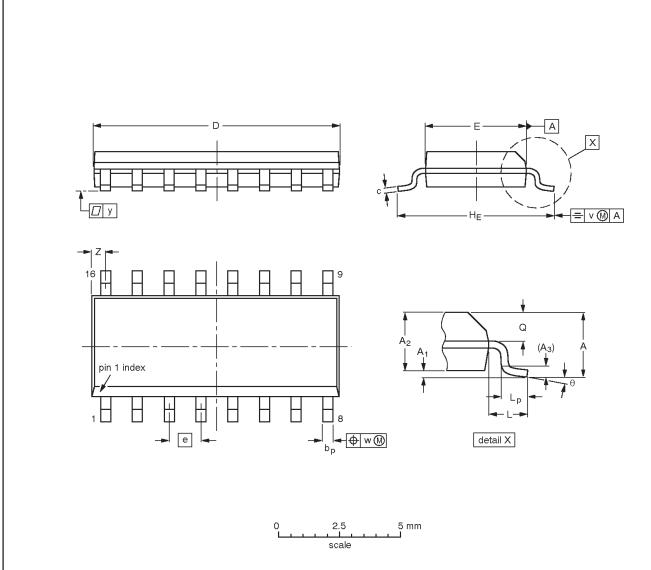
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT38-4				□ •	<del>92-11-17</del> 95-01-14

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### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	e	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1330E DATE
SOT109-1	076E07S	MS-012AC			<del>95-01-23</del> 97-05-22

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#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
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<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

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